

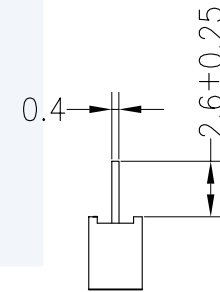
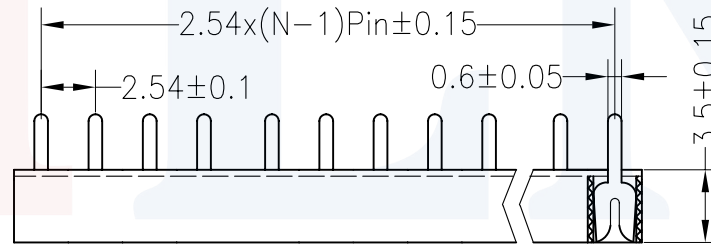
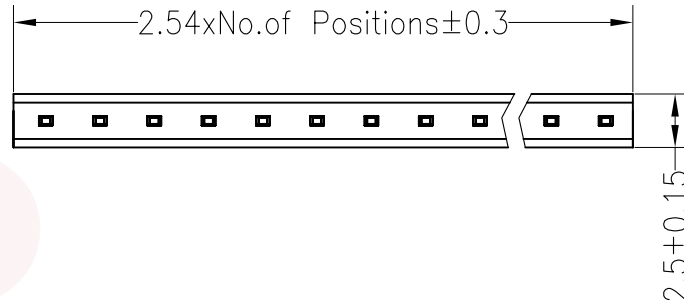
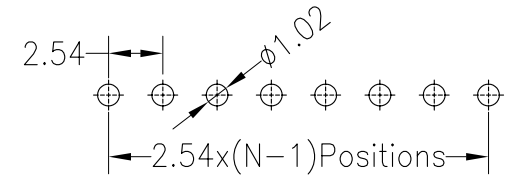


SPECIFICATIONS

Rated Current:3.0AMP
 Contact Resistance:20mΩ Max
 Withstand Voltage:1000V AC/DC
 Insulation Resistance:1000MΩ Min
 Operation Temperature:-40°C to +105°C

Contact Material:Brass
 Contact Plating:Au or Sn Over Ni
 Insulator Material:Polyester(UL94V-0)
 Standard: PA6T
 Max.Processing Temp: 230°C for 30-60 seconds
 (260°C for 10 seconds)

Recommended P.C.B Layout(Top Side)
 (PCB BOARD TOLERANCE±0.05)



Ordering Information

2235 01 XX X N XX SYX 01

- No. of Pins Per Row 1*1~1*40
- Insulator Material Option
 - A=BK-PBT
 - B=BK-PA66
 - C=BK-PA6T
 - D=BK-PA46
 - F=BK-LCP
- Contact Plating Option
 - G0:Gold Flash
 - G2:5U" Gold
 - G3:10U" Gold
 - G4:15U" Gold
 - G5:30U" Gold
 - S0:Gold Flash/Tin
 - SN:Tin
- Packing
 - O=Pe Bag
 - A=Tray
 - T=Tube
 - P=Tube+Cap
 - R=Reel+Cap
 - M=Reel+Mylar

				OPERATION		DRAW	YiYuSheng	12.03.28	SCALE	FIT	JiLN ® 深圳市锦凌电子有限公司 SHENZHEN JINLING ELECTRONIC CO.,LTD Tel: 86-755-2997-5806/5802 Fax: 86-755-2997-5992	
				X.X	±0.30				UNIT	mm		
				CHECK				SIZE	A4	PART NO.		223501XXXNXXSYX01
				APPROVE				SHEET	1/1	TITLE:		2.54PF H3.5mm 1xNpin 180° DIP
REV	DATE	MODIFICATION DESCRIPTION	CHANGE	DIM	TOL			PROJ.				